

128Mb (2M×4Bank×16) Synchronous DRAM

Descriptions

The H2A11281633B is Synchronous Dynamic Random Access Memory (SDRAM) organized as 2Mega words x 4 banks by 16 bits. All inputs and outputs are synchronized with the positive edge of the clock.

The 128Mb SDRAM uses synchronized pipelined architecture to achieve high speed data transfer rates and is designed to operate at 3.3V low power memory system. It also provides auto refresh with power saving / down mode. All inputs and outputs voltage levels are compatible with LVTTL.

Available packages: TSOPII 54P 400mil.

- All Inputs are Sampled at the Rising Edge of the System Clock
- Auto Refresh and Self Refresh
- 4,096 Refresh Cycles / 64ms (15.625us)

Features

- Fully Synchronous to Positive Clock Edge
- Single 3.3V ±0.3V Power Supply
- LVTTL Compatible with Multiplexed Address
- Programmable Burst Length (B/L) 1, 2, 4, 8
 or Full Page
- Programmable CAS Latency (C/L) 2 or 3
- Data Mask (DQM) for Read / Write Masking
- Programmable Wrap Sequence
- Sequential (B/L = 1/2/4/8/full Page)
- Interleave (B/L = 1/2/4/8)
- Burst Read with Single-bit Write Operation

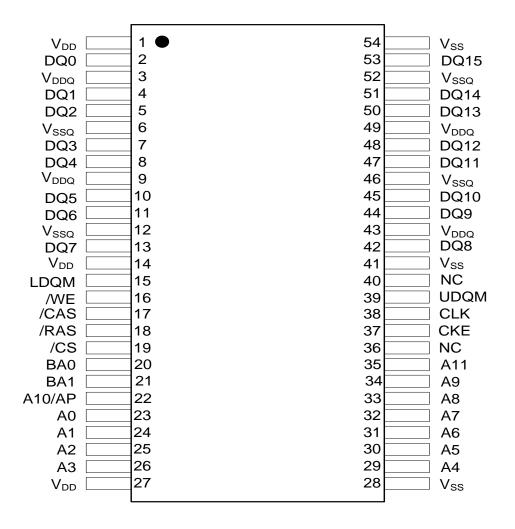




Ordering Information

Part No	Organization	Max. Frequency	Package	Grade
H2A11281633B81C	8M X 16	133MHz @ CL3	54pin TSOP(II)	Commercial
H2A11281633BL1C	8M X 16	143MHz @ CL3	54pin TSOP(II)	Commercial
H2A11281633BM1C	8M X 16	166MHz @ CL3	54pin TSOP(II)	Commercial

Pin Assignment



54pin TSOP-II / (400mil × 875mil) / (0.8mm Pin pitch)





Pin Description (Simplified)

Pin	Name	Function			
38	CLK	(System Clock)			
30	CLK	Master clock input (Active on the positive rising edge)			
19	/CS	(Chip Select)			
19	700	Selects chip when active			
		(Clock Enable)			
37	CKE	Activates the CLK when "H" and deactivates when "L".			
	ONE	CKE should be enabled at least one cycle prior to new			
		command. Disable input buffers for power down in standby.			
		(Address)			
		Row address (A0 to A11) is determined by A0 to A11 level at			
		the bank active command cycle CLK rising edge.			
		CA (CA0 to CA7) is determined by A0 to A7 level at the read or			
23~26, 22, 29~35	A0~A11	write command cycle CLK rising edge.			
		And this column address becomes burst access start address.			
		A10 defines the pre-charge mode. When A10= High at the			
		pre-charge command cycle, all banks are pre-charged.			
		But when A10= Low at the pre-charge command cycle, only the			
		bank that is selected by BA0/BA1 is pre-charged.			
20, 21	BA0, BA1	(Bank Address) Selects which bank is to be active.			
		(Row Address Strobe)			
18	/RAS				
10	/11/10	Latches Row Addresses on the positive rising edge of the CLK with /RAS "L". Enables row access & pre-charge.			
		(Column Address Strobe)			
17	/CAS	Latches Column Addresses on the positive rising edge of the			
17	7070	CLK with /CAS low. Enables column access.			
		(Write Enable)			
16	WΕ	Latches Column Addresses on the positive rising edge of the			
1.0	,	CLK with /CAS low. Enables column access.			
/		(Data Input / Output Mask)			
39 / 15	UDQM / LDQM	DQM controls I/O buffers.			
2, 4, 5, 7, 8, 10,		(Data Input / Output)			
11, 13, 42, 44, 45,	DQ0~DQ15	DQ pins have the same function as I/O pins on a conventional			
47, 48, 50, 51, 53		DRAM.			
1,14,27/	M /M	(Power Supply / Ground)			
28,41,54	V_{DD}/V_{SS}	V _{DD} and V _{SS} are power supply pins for internal circuits.			
3, 9, 43, 49 /	\/ /\/	(Power Supply / Ground)			
6, 12, 46, 52	V_{DDQ}/V_{SSQ}	V _{DDQ} and V _{SSQ} are power supply pins for the output buffers.			
		(No Connection)			
36,40	NC	This pin is recommended to be left No Connection on the			
		device.			



Absolute Maximum Rating

Symbol	Item	Rati	ng	Units	
V_{IN}, V_{OUT}	Input, Output Voltage	$-0.5 \sim V_{DD} + 0.5 \ (\le 4.6 \text{V max.})$		V	
V_{DD}, V_{DDQ}	Power Supply Voltage	-0.5 ~	-0.5 ~ +4.6		
T _{OP}	Operating Temperature Range	Commercial	0 ~ +70	°C	
T _{STG}	Storage Temperature Range	-55 ~ +	+150	°C	
P_D	Power Dissipation	1	W		
I _{OS}	Short Circuit Current	50		mA	

Note: Caution Exposing the device to stress above those listed in Absolute Maximum Ratings could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational section of this specification. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

Capacitance (V_{CC} =3.3V, f=1MHz, T_A =25 $^{\circ}C$)

Symbol	Parameter	Min.	Тур.	Max.	Units
C _{CLK}	Clock Capacitance	-	-	3.5	рF
Cı	Input Capacitance for CLK, CKE, Address, /CS, /RAS, /CAS, /WE, DQML, DQMU	-		3.8	pF
Co	Input / Output Capacitance	-	-	6.5	pF

Recommended DC Operating Conditions (T_A =-0°C ~+70°C)

Symbol	Parameter	Min.	Тур.	Max.	Units
V_{DD}	Power Supply Voltage	3.0	3.3	3.6	V
V_{DDQ}	Power Supply Voltage (for I/O Buffer)	3.0	3.3	3.6	V
V_{IH}	Input Logic High Voltage	2.0	-	V _{DD} +0.3	V
V_{IL}	Input Logic Low Voltage	-0.3	-	0.8	V

Note: * All voltages referred to V_{SS}.



^{*} V_{IH} (max.) = V_{DD} / V_{DDQ} +1.5V for pulse width \leq 5ns

^{*} V_{IL} (min.) = V_{DD} / V_{SSQ} -1.5V for pulse width \leq 5ns



Recommended DC Operating Conditions

 $(V_{DD}=3.3V\pm0.3V, T_{A}=0^{\circ}C \sim 70^{\circ}C)$

Symbol	Parameter	Test Conditions	Max.	Units
I _{DD1}	Operating Current (Note 1)	Burst length=1, t _{RC} ≥t _{RC} (min.), I _{OL} =0mA, One bank active	50	mA
I_{DD2P}	Precharge Standby Current in	CKE≤V _{IL} (max.), t _{CK} =15ns	2	mA
I _{DD2PS}	Power Down Mode	$CKE \le V_{IL}(max.), t_{CK} = \infty$	2	mA
I _{DD2N}	Precharge Standby Current in Non-power Down Mode	CKE≥V _{IL} (min.), t _{CK} =15ns, /CS≥V _{IH} (min.) Input signals are changed one time during 30ns	35	mA
I _{DD2NS}	·	CKE≥V _{IL} (min.), t _{CK} = ∞ , Input signals are stable	12	mA
I _{DD3P}	Active Standby Current in	CKE≤V _{IL} (max.), t _{CK} =15ns	7	mA
I _{DD3PS}	Power Down Mode	CKE≤V _{IL} (max.), t _{CK} = ∞	7	mA
I _{DD3N}	Active Standby Current in Non-power Down Mode	CKE≥V _{IL} (min.), t _{CK} =15ns, /CS≥V _{IH} (min.) Input signals are changed one time during 30ns	40	mA
I _{DD3NS}	·	CKE≥V _{IL} (min.), t _{CK} = ∞ , Input signals are stable	35	mA
I _{DD4}	Operating Current (Burst Mode) (Note 2)	t _{CCD} ≥2CLKs, I _{OL} =0mA	75	mA
I _{DD5}	Refresh Current (Note 3)	t _{RC} ≥t _{RC} (min.)	65	mA
I _{DD6}	Self Refresh Current	CKE≤0.2V	2000 ^(Note 4)	uA

^{*}All voltages referenced to V_{SS}.

Note 1: I_{CC1} depends on output loading and cycle rates.

Specified values are obtained with the output open.

Input signals are changed only one time during t_{CK} (min.)

Note 2: I_{CC4} depends on output loading and cycle rates.

Specified values are obtained with the output open.

Input signals are changed only one time during t_{CK} (min.)

Note 3: Input signals are changed only one time during t_{CK} (min.)

Note 4: Standard power version.



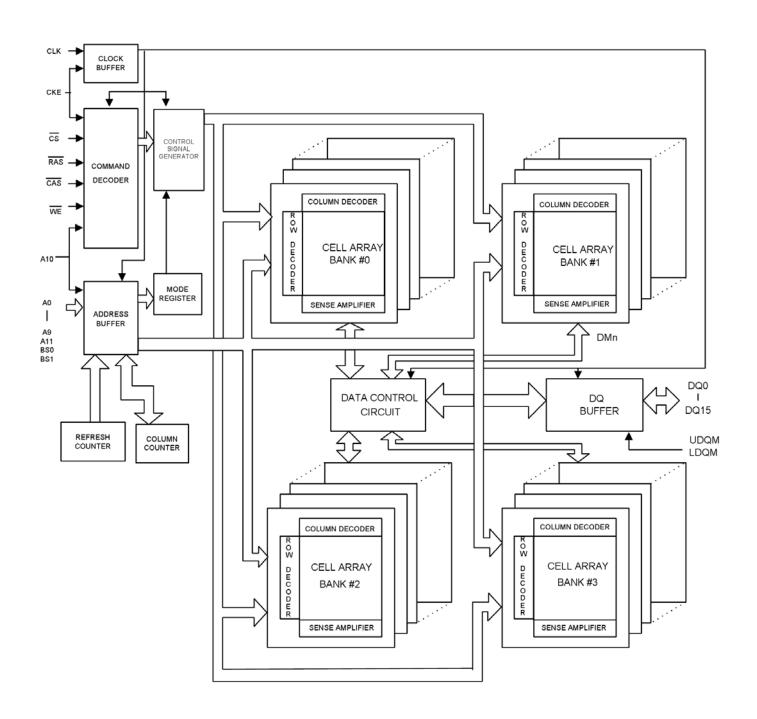


Recommended DC Operating Conditions (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
I _{IL}	Input Leakage Current	$0 \le V_I \le V_{DDQ}$, $V_{DDQ} = V_{DD}$ All other pins not under test=0V	-5	-	5	uA
I _{OL}	Output Leakage Current	0≤V _O ≤V _{DDQ} , D _{OUT} is disabled	-5	-	5	uA
V _{OH}	High Level Output Voltage	I _O =-4mA	2.4	-	-	V
V_{OL}	Low Level Output Voltage	I _O =+4mA	-	-	0.4	V



Block Diagram



Note: The cell array configuration is 4096 * 512 * 16.

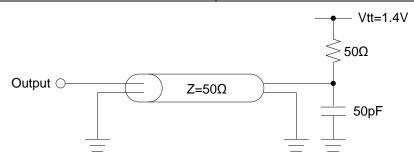




AC Operating Test Conditions

 $(V_{DD}=3.3V\pm0.3V, T_{A}=0^{\circ}C \sim 70^{\circ}C)$

Item	Conditions
Output Reference Level	1.4V/1.4V
Output Load	See diagram as below
Input Signal Level	2.4V/0.4V
Transition Time of Input Signals	2ns
Input Reference Level	1.4V



AC Operating Test Characteristics

 $(V_{DD}=3.3V\pm0.3V, T_{A}=0^{\circ}C \sim 70^{\circ}C)$

Cumbal	Parameter		166	MHz	143	MHz	133	MHz	Linita
Symbol	Parameter	Parameter		Max.	Min.	Max.	Min.	Max.	Units
	Clock Cycle Time	CL=3	6	1000	7	1000	7.5	1000	20
t _{CK}	Clock Cycle Time	CL=2	8	1000	9	1000	10	1000	ns
_	Access Time form CLK	CL=3		5		5		6	
t _{AC}	Access Time form CLK			6		6		6	ns
t _{CH}	CLK High Level Width		2		2		2		ns
t _{CL}	CLK Low Level Width		2		2		2		ns
	Data antillabilities a	CL=3	3		3		3		
t _{OH}	Data-out Hold Time	CL=2							ns
_	Data-out High Impedance	CL=3	2	5	2	6	2	7	
t _{HZ}	Time (Note 5)	CL=2							ns
t _{LZ}	Data-out Low Impedance Time		0		0		0		ns
t _{IH}	Input Hold Time		1		1		1		ns
t _{IS}	Input Setup Time		1.5		1.5		1.5		ns

 $^{^{\}star}$ All voltages referenced to V_{SS} .

Note 5: t_{HZ} defines the time at which the output achieve the open circuit condition and is not referenced to output voltage levels.





AC Operating Test Characteristics (Continued)

 $(V_{DD}=3.3V\pm0.3V, T_A=0^{\circ}C \sim 70^{\circ}C)$

Cymbal	Parameter		166	MHz	143	MHz	133	MHz	Unito
Symbol			Min.	Min. Max.		Max.	Min.	Max.	Units
t _{RC}	ACTIVE to ACTIVE Comma Period (Note 6)	ınd	60		63		65		ns
t _{RAS}	ACTIVE to PRECHARGE Command Period (Note 6)		40	100k	42	100k	45	100k	ns
t _{RP}	PRECHARGE to ACTIVE Command Period (Note 6)	15		18		21		ns	
t _{RCD}	ACTIVE to READ/WRITE D Time (Note 6)	18		20		20		ns	
t _{RRD}	ACTIVE(one) to ACTIVE(an Command (Note 6)	other)	12		14		18		ns
t _{CCD}	READ/WRITE Command to READ/WRITE Command	1	1		1		1		CLK
t _{DPL}	Date-in to PRECHARGE Command		2		2		2		CLK
t _{BDL}	Date-in to BURST Stop Command		1		1		1		CLK
	Data-out to High CL=3		3		3		3		01.14
t _{ROH} Impedance from PRECHARGE Command CL		CL=2	2		2		2		CLK
t _{REF}	Refresh Time (4,096 cycle)			64		64		64	ms

^{*} All voltages referenced to V_{SS}.

Note 6: These parameters account for the number of clock cycles and depend on the operating frequency of the clock, as follows:

The number of clock cycles = Specified value of timing/clock period (Count Fractions as a whole number)

Recommended Power On and Initialization

The following power on and initialization sequence guarantees the device is preconditioned to each user's specific needs. (Like a conventional DRAM) During power on, all V_{DD} and V_{DDQ} pins must be built up simultaneously to the specified voltage when the input signals are held in the "NOP" state. The power on voltage must not exceed V_{DD} +0.3V on any of the input pins or V_{DD} supplies. (CLK signal started at same time)

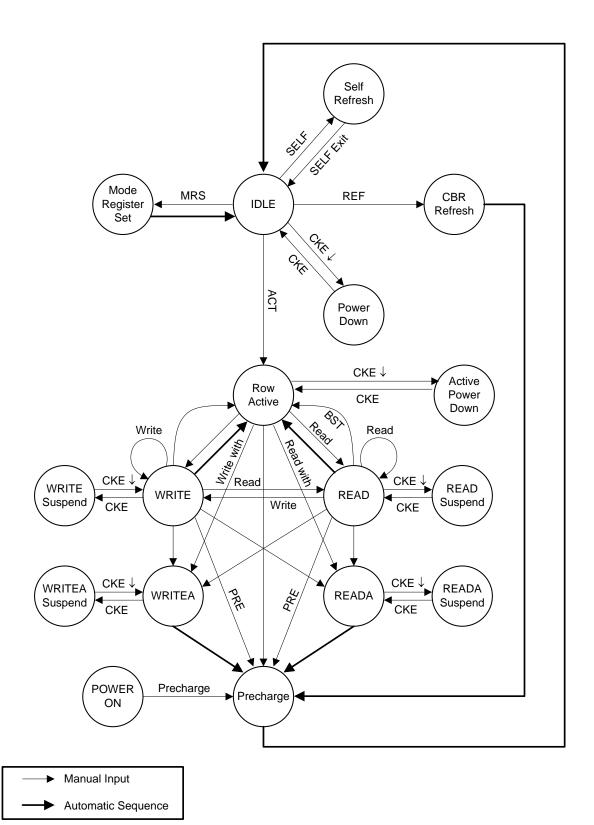
After power on, an initial pause of 200 µs is required followed by a precharge of all banks using the precharge command.

To prevent data contention on the DQ bus during power on, it is required that the DQM and CKE pins be held high during the initial pause period. Once all banks have been precharged, the Mode Register Set Command must be issued to initialize the Mode Register. A minimum of eight Auto Refresh cycles (CBR) are also required, and these may be done before or after programming the Mode Register.





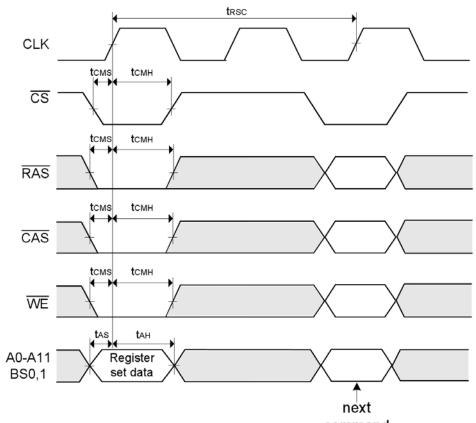
Simplified State Diagram







Address Input for Mode Register Set



					command		
A0						Burst	Length
A.4	1	D	◀──		A2 A1 A0	Sequential	Interleave
A1		Burst Length			0 0 0	1	1
A2	1				0 0 1	2	2
			-		0 1 0	4	4
A3	Ad	ldressing Mode	◀──	\neg	0 1 1	8	8
A4			1		1 0 0	Reserved	
					1 1 0	i iveseived	Reserved
A5	'	CAS Latency	←──		1 1 1	Full Page	
A6	1				10		na Mada
7.0				_	A3	Addressi	
A7	"0"	(Test Mode)			0		ential
			1		1	Inter	leave
A8	"0"	Reserved]		A6 A5 A4	CAS L	atency
A9		Write Mode	 ←	_	0 0 0	Rese	erved
		T	`		0 0 1	Rese	erved
A10	"0"				0 1 0	2	2
A11	"0"				0 1 1	3	
	U	Reserved			1 0 0	Rese	erved
BS0	"0"			L	A9	Single W	rite Mode
BS1	"0"				0	Burst read an	
501			J		1	Burst read an	

^{* &}quot;Reserved" should stay "0" during MRS cycle.



Burst Type (A3)

Burst Length	A2	A1	A0	Sequential Addressing	Interleave Addressing
2	Х	Χ	0	0 1	0 1
2	Х	Х	0	1 0	1 0
	Χ	0	0	0123	0123
4	Х	0	1	1230	1032
4	Χ	1	0	2301	2301
	Χ	1	1	3012	3210
	0	0	0	01234567	01234567
	0	0	1	12345670	10325476
	0	1	0	23456701	23016745
8	0	1	1	34567012	32107654
0	1	0	0	45670123	45670123
	1	0	1	56701234	54761032
	1	1	0	67012345	67452301
	1	1	1	70123456	76543210
Full Page*	n	n	n	Cn Cn+1 Cn+2	-

^{*} Page length is a function of I/O organization and column addressing ×16 (CA0 ~ CA7):

Full page = 256bits

1. Command Truth Table

Command	Symbol	CK	Е	/CS	/RAS	/CAS	/WE	BA0,	A10	A11,
Command	Syllibol	n-1	n	2	/KAS	/CAS	/VVE	BA1	AIU	A9~A10
Ignore Command	DESL	Н	Χ	Ι	X	Х	Χ	Х	Χ	Χ
No Operation	NOP	Н	Χ	L	Н	Н	Н	Χ	Х	Χ
Burst Stop	BSTH	Н	Х	L	Н	Н	L	Х	Х	Х
Read	READ	Н	Χ	L	Н	L	Н	V	L	V
Read with Auto Pre-charge	READA	Н	Χ	L	Н	L	Н	V	Н	V
Write	WRIT	Н	Χ	L	Н	L	L	V	L	V
Write with Auto Pre-charge	WRITA	Н	Χ	L	L	Н	Н	V	Н	V
Bank Activate	ACT	Н	Χ	L	L	Н	Н	V	V	V
Pre-charge Select Bank	PRE	Н	Χ	L	L	Н	L	V	L	Х
Pre-charge All Banks	PALL	Н	Х	L	L	Н	L	Х	Н	Х
Mode Register Set	MRS	Н	Χ	L	L	L	L	L	L	V

H = High level, L = Low level, X = High or Low level (Don't care), V = Valid data input





2. DQM Truth Table

Command	Symbol	C	KE	/00
Command	Symbol	n-1	n	- /CS
Data Write/Output Enable	ENB	Н	X	Н
Data Mask/Output Disable	MASK	Н	Х	L
Upper Byte Write Enable/Output Enable	BSTH	Н	Х	L
Read	READ	Н	Х	L
Read with Auto Pre-charge	READA	Н	Х	L
Write	WRIT	Н	Х	L
Write with Auto Pre-charge	WRITA	Н	Х	L
Bank Activate	ACT	Н	Х	L
Pre-charge Select Bank	PRE	Н	Х	L
Pre-charge All Banks	PALL	Н	Х	L
Mode Register Set	MRS	Н	Х	L

H = High level, L = Low level, X = High or Low level (Don't care), V = Valid data input

3. CKE Truth Table

Item	Command	Symbo	CK	Έ	/CS	/RA	/CA	/WE	Addr.	
item	Command	i I	n-	n	/63	S	S	/VV E	Addr.	
Activating	Clock Suspend Mode Entry		Н	L	Χ	Χ	Χ	X	Х	
Any	Clock Suspend Mode		L	L	Χ	X	Χ	Χ	Х	
Clock Suspend	Clock Suspend Mode Exit		L	Н	Х	Х	Х	Х	Х	
Idle	CBR Refresh Command	REF	Н	Н	L	L	L	Н	Х	
Idle	Self Refresh Entry	SELF	Н	L	L	L	L	Н	Х	
Self Refresh	Self Refresh Exit		L	Н	L	Η	Η	Н	Х	
Sell Reflesh	Sell Reflesh Exit		L	Η	I	Χ	Χ	Χ	X	
Idle	Power Down Entry		Ι	L	Х	Χ	Χ	Χ	X	
Power Down	Power Down Exit		L	Н	Χ	Х	Χ	Χ	Х	

Remark H = High level, L = Low level, X = High or Low level (Don't care)





Current State	/CS	/R	/C	/W	Addr.	Command	Action
	Н	Х	Х	Х	Х	DESL	Nop or power down (Note 8)
	L	Н	Н	Х	Х	NOP or BST	Nop or power down (Note 8)
	L	Н	L	Н	BA/CA/A10	READ/READA	ILLEGAL (Note 9)
	L H L L		BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)		
1.01.		Н	H	BA/RA	ACT	Row activating	
	L	L	Н	L	BA, A10	PRE/PALL	Nop
	L	L	L	Н	Х	REF/SELF	Refresh or self refresh (Note 10)
	L	L	L	L	Op-Code	MRS	Mode register accessing
	Н	Х	Χ	Χ	X	DESL	Nop
	L	Н	Н	Χ	X	NOP or BST	Nop
	L	Н	L	Н	BA/CA/A10	READ/READA	Begin read: Determine AP (Note 11)
Row	L	Н	L	L	BA/CA/A10	WRIT/WRITA	Begin write: Determine AP (Note 11)
Active	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	Pre-charge (Note 12)
	L	L	L	Н	Х	REF/SELF	ILLEGAL (Note 10)
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Х	Х	Х	Х	DESL	Continue burst to end → Row active
	L	Н	Н	Н	Х	NOP	Continue burst to end → Row active
	L	Н	Н	L	X	BST	Burst stop → Row active
	L	Н	L	Н	BA/CA/A10	READ/READA	Terminate burst, new read: Determine AP (Note 13)
Read	L	L	L	L	BA/CA/A10	WRIT/WRITA	Terminate burst, start write: Determine AP (Note 13, 14)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	Terminate burst, pre-charging (Note 10)
	L	L	L	Н	X	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Х	Х	Χ	Х	DESL	Continue burst to end → Write recovering
	L	Н	Н	Н	Х	NOP	Continue burst to end → Write recovering
	L	Н	Н	L	X	BST	Burst stop → Row active
	L	Н	L	Н	BA/CA/A10	READ/READA	Terminate burst, start read: Determine AP 7, 8 (Note 13, 14)
Write	L	L	L	L	BA/CA/A10	WRIT/WRITA	Terminate burst, new write: Determine AP 7 (Note 13)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	Terminate burst, pre-charging (Note 15)
	L	L	L	Н	X	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL

Remark H = High level, L = Low level, X = High or Low level (Don't care)





4. Operative Command Table (Continued) (Note 7)

Current State	/cs	/R	/C	/W	Addr.	Command	Action
	Н	Х	Х	Х	X	DESL	Continue burst to end → Pre-charging
	L	Н	Н	Η	X	NOP	Continue burst to end → Pre-charging
	L	Н	Н	L	X	BST	ILLEGAL
Read with	L	Н	L	Н	BA/CA/A10	READ/READA	ILLEGAL (Note 9)
AP	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	ILLEGAL (Note 9)
	L	L	L	Н	Х	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Х	Х	Χ	X	DESL	Burst to end → Write recovering with auto pre-charge
	L	Н	Н	Н	X	NOP	Continue burst to end → Write recovering with auto pre-charge
	L	Н	Н	L	Х	BST	ILLEGAL
Write with	L	Н	L	Н	BA/CA/A10	READ/READA	ILLEGAL (Note 9)
AP	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	ILLEGAL (Note 9)
	L	L	L	Н	Х	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Χ	Χ	Χ	X	DESL	$Nop \rightarrow Enter idle after t_{RP}$
	L	Н	Н	Н	X	NOP	$Nop \rightarrow Enter idle after t_{RP}$
	L	Н	Н	L	X	BST	ILLEGAL
	L	Н	L	Н	BA/CA/A10	READ/READA	ILLEGAL (Note 9)
Pre-charging	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	$Nop \rightarrow Enter idle after t_{RP}$
	L	L	L	Н	Х	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Χ	Χ	Χ	X	DESL	$Nop \rightarrow Enter idle after t_{RCD}$
	L	Н	Η	Н	X	NOP	Nop → Enter idle after t _{RCD}
	L	Н	Н	L	Х	BST	ILLEGAL (Note 9)
Row	L	Н	L	Н	BA/CA/A10	READ/READA	ILLLOAL
Activating	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9, 16)
	L	L	Η	L	BA, A10	PRE/PALL	ILLEGAL (Note 9)
	L	L	L	Н	X	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL

Remark H = High level, L = Low level, X = High or Low level (Don't care), AP = Auto Pre-charge





4. Operative Command Table (Continued) (Note 7)

Current State	/cs	/R	/C	/W	Addr.	Command	Action
	Н	Х	Х	Χ	Х	DESL	Nop → Enter row active after t _{DPL}
	L	Η	Η	Η	X	NOP	Nop \rightarrow Enter row active after t_{DPL}
	L	Η	Η	L	X	BST	Nop \rightarrow Enter row active after t_{DPL}
	L	Н	L	Н	BA/CA/A10	READ/READA	Start read, Determine AP
Write Recovering	L	Н	L	L	BA/CA/A10	WRIT/WRITA	New write, Determine AP (Note 14)
Recovering	L	L	Η	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	ILLEGAL (Note 9)
	L	L	L	Н	Х	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Χ	Χ	Χ	X	DESL	Nop → Enter pre-charge after t _{DPL}
	L	Н	Н	Н	X	NOP	Nop → Enter pre-charge after t _{DPL}
	L	Н	Н	L	X	BST	Nop → Enter pre-charge after t _{DPL}
Write	L	Η	L	Н	BA/CA/A10	READ/READA	ILLEGAL (Note 9, 14)
Recovering	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
with AP	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Η	L	BA, A10	PRE/PALL	ILLEGAL
	L	L	L	Н	X	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Χ	Χ	Χ	X	DESL	Nop \rightarrow Enter idle after t_{RC}
	L	Н	Н	Χ	X	NOP/BST	Nop \rightarrow Enter idle after t_{RC}
Refreshing	L	Н	L	Χ	X	READ/WRIT	ILLEGAL
	L	L	Н	Χ	X	ACT/PRE/PALL	ILLEGAL
	L	L	L	Χ	Х	REF/SELF/MRS	ILLEGAL
	Н	Χ	Х	Χ	X	DESL	Nop
Mode	L	Н	Н	Н	X	NOP	Nop
Register	L	Н	Н	L	X	BST	ILLEGAL
Accessing	L	Н	L	Χ	X	READ/WRIT	ILLEGAL
	L	L	Χ	Х	Х	ACT/PRE/PALL/ REF/SELF/MRS	ILLEGAL

Remark H = High level, L = Low level, X = High or Low level (Don't care), AP = Auto Pre-charge

Note 7: All entries assume that CKE was active (High level) during the preceding clock cycle.

Note 8: If all banks are idle, and CKE is inactive (Low level), SDRAM will enter Power down mode.

All input buffers except CKE will be disabled.

Note 9: Illegal to bank in specified states;

Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.

Note 10: If all banks are idle, and CKE is inactive (Low level), SDRAM will enter Self refresh mode.

All input buffers except CKE will be disabled.

Note 11: Illegal if t_{RCD} is not satisfied.

Note 12: Illegal if t_{RAS} is not satisfied.

Note 13: Must satisfy burst interrupt condition.







Note 14: Must satisfy bus contention, bus turn around, and/or write recovery requirements.

Note 15: Must mask preceding data which don't satisfy t_{DPL} .

Note 16: Illegal if t_{RRD} is not satisfied.





5. Command Truth Table for CKE

Current State	X H H	/CS X H	/R X	/C	/W	Addr.	Action	
Self Refresh L	H		Х	V				
Self Refresh L	Н	lн		Х	Х	Х	INVALID, CLK(n-1) would exit self refresh	
L			Χ	Χ	Χ	X	Self refresh recovery	
		L	Н	Н	Χ	X	Self refresh recovery	
	Н	L	Н	L	Χ	X	ILLEGAL	
L	Н	L	L	Χ	Χ	X	ILLEGAL	
L	L	X	Χ	Χ	Χ	X	Maintain self refresh	
Н	Н	Н	Χ	Χ	Χ	X	Idle after t _{RC}	
Н	Н	L	Н	Н	Χ	X	Idle after t _{RC}	
Н	Н	L	Н	L	Χ	X	ILLEGAL	
Self Refresh H	Н	L	L	Χ	Χ	X	ILLEGAL	
Recovery H	L	Н	Χ	Χ	Χ	X	ILLEGAL	
Н	L	L	Η	Н	Χ	X	ILLEGAL	
Н	L	L	Η	L	Χ	X	ILLEGAL	
Н	L	L	L	Χ	Χ	Х	ILLEGAL	
Н	Х	Х	Х	Х	Х	Х	INVALID, CLK(n-1) would exit power down	
Power Down L	Н	Х	Х	Χ	Χ	Х	Exit power down → Idle	
L	L	Х	Χ	Χ	Х	Х	Maintain power down mode	
Н	Н	Н	Х	Χ	Χ			
Н	Н	L	Н	Χ	Χ		Refer to operations in Operative Command Table	
Н	Н	L	L	Н	Χ		Command Table	
Н	Н	L	L	L	Н	Х	Refresh	
Н	Н	L	L	L	L	Op-Code		
Both Banks H	L	Н	Χ	Χ	Χ		Refer to operations in Operative	
Idle H	L	L	Н	Χ	Χ		Command Table	
H	L	L	L	Н	Χ			
H	L	L	L	L	Н	Χ	Self refresh (Note 17)	
н	L	L	L	L	L	Op-Code	Refer to operations in Operative Command Table	
L	Х	Х	Х	Х	Х	Χ	Power down (Note 17)	
Row Active	Х	Х	Х	Х	Х	Х	Refer to operations in Operative Command Table	
L	Х	Х	Х	Х	Х	Х	Power down (Note 17)	
Н	Н	Х	Х	Х	Х		Refer to operations in Operative Command Table	
Any State Other than Listed above	L	Х	Х	Х	Х	Х	Begin clock suspend next cycle (Note 18)	
L	Н	Х	Х	Х	Х	Х	Exit clock suspend next cycle	
L	L	X	Х	Х	Х	X	Maintain clock suspend	

Remark: H = High level, L = Low level, X = High or Low level (Don't care)

Notes 17: Self refresh can be entered only from the both banks idle state.

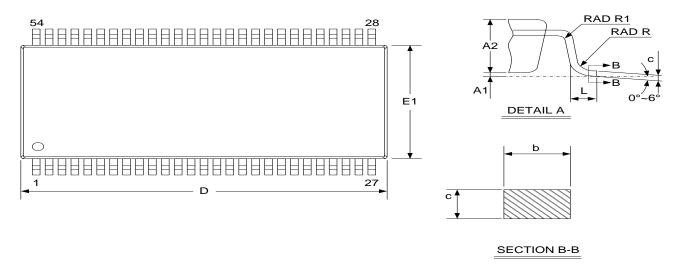
Power down can be entered only from both banks idle or row active state.

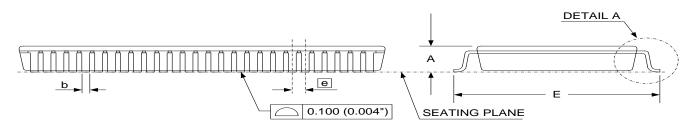
Notes 18: Must be legal command as defined in Operative Command Table





Package Description





DIM	N	/ILLIMETER:	S	INCHES			
DIIVI	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	-	-	1.20	-	-	0.047	
A1	0.05	-	0.15	0.002	1	0.006	
A2	0.95	1.00	1.05	0.037	0.039	0.041	
b	0.30	-	0.45	0.012	1	0.018	
С	0.12	_	0.21	0.005	1	0.008	
D	22.09	22.22	22.35	0.870	0.875	0.880	
е		0.80 BASIC		0.0315 BASIC			
E	11.56	11.76	11.96	0.455	0.463	0.471	
E1	10.03	10.16	10.29	0.395	0.400	0.405	
L	0.40	0.50	0.60	0.016	0.020	0.024	
R	0.12	_	0.25	0.005	_	0.010	
R1	0.12	_	_	0.005	_	_	

^{*} Controlling dimension: millimeters

- * Dimension D does not include mold protrusion. Mold protrusion shall not exceed 0.15mm (0.006") per side. Dimension E1 does not include interlead protrusion. Interlead protrusion shall not exceed 0.25mm (0.01") per side.
- * Dimension b does not include dambar protrusions/intrusion. Allowable dambar protrusion shall not cause the lead to be wider than the MAX b dimension by more than 0.13mm. Dambar intrusion shall not cause the lead to be narrower than the MIN b dimension by more than 0.07mm.





Revision History

Revision No.	History	Draft Date	Editor	Remark
0.1	Initial Release.	Jul. 2014	David Chen	N/A
1.0	First SPEC. release.	Sep. 2014	David Chen	N/A

